





OTHER OPTION

-K

= (5.50 mm) .217" DIA

Polyimide film Pick & Place Pad

(N/A with – PC4)

-PC4

= 4 Power Pins/End

(N/A with -A)

(0.635 mm) .025" PITCH • QMSS/QFSS SERIES

QMSS Board Mates: QFSS

QFSS Board Mates: OMSS

QMSS/QFSS

Standoffs: SO

SPECIFICATIONS

Insulator Material: Liquid Crystal Polymer
Terminal, Ground Plane & Shield Material: Phosphor Bronze Phosphor Biolize
Plating:
Au over 50 μ" (1.27 μm) Ni
(Tin on Ground Plane Tail)
Operating Temp Range:
-55 °C to +125 °C
Voltage Rating:
300 VAC when mated

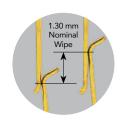
PROCESSING

Lead-Free Solderable:

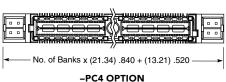
SMT Lead Coplanarity: (0.10 mm) .004" max (0.26 - 0.78)

Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com



PINS PER ROW NO. OF PAIRS **PLATING QMSS** 06.75 **TYPE** OPTION **-026, -052, -078** (52 total pins per bank / 40 signals + 12 grounds to shield = -D) -D = 10 µ" (0.25 µm) gold on contact, Matte Tin on tail = Single-Ended -016, -032, -048 -D-DP (16 pairs per bank = -D-DP) = Differential Pair No. of Banks x (21.34) .840 - (0.51) .020 **←**(6.35) (6.35)(6.73) .250 265



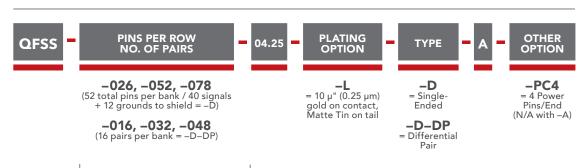
-D

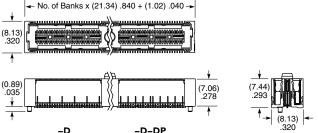
PACKAGING OPTION

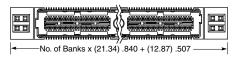
Tape & Reel Options (-TR & -FR) available. Visit series web page and view engineering prints for complete specifications.

View complete specifications at: samtec.com?QMSS

-D-DP







Tape & Reel Options (-TR & -FR) available. Visit series web

PACKAGING

OPTION

page and view engineering prints for complete specifications.

-PC4 OPTION

View complete specifications at: samtec.com?QFSS



Some lengths, styles and options are non-standard, non-returnable.